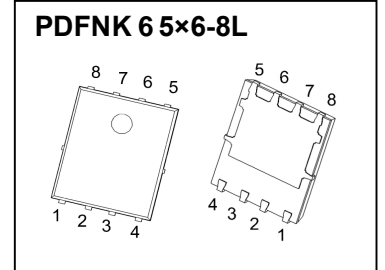




# PDFNK 6 5×6-8L Plastic-Encapsulate MOSFETS

## AC65SN10L N-Channel Power MOSFET

$V_{(BR)DSS}$	$R_{DS(on)TYP}$	$I_D$
FEX	11m OFEX	ÍÍCE
	F5.5{ OIEX	



### DESCRIPTION

V@ÁOÍÍÙPFLÁ~•^ÁSGTÁc&@ [[|^ÁæáÁ^•ã}ÁçÁ]i|çã^Á  
 ^ç&|^}cÜÖÜQPD, ÁãOÍ, Áæ^Á&@^ÉQ&áÁ^Á•^áÁ, Áã^ÁçãçÁ  
 [Áç]|ãã}•Á

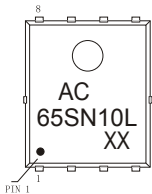
### FEATURES

- Pã@Ú, ^|ÁæáÁ^•ã}ÁçÁ]i|çã^Á
- ŠãÁ, æ&@
- Pã@Ú, ^|ÁæáÁ^•ã}ÁçÁ]i|çã^Á, ÜÖÜQPD
- ŠãÁ^•ã}ÁçÁ]i|çã^Á
- Ö[[áÁçãçÁ]i|çã^Á
- Öç&|^}çãã^ÁçÁ]i|çã^Á

### APPLICATIONS

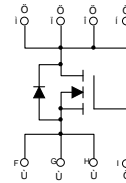
- ÚTÚÚÁæáÁ^•ã}ÁçÁ]i|çã^Á
- PãáÁ, æ&@áÁçÁ]i|çã^Á
- W, çãã^ÁçÁ]i|çã^Á
- Ú, ^|ÁæáÁ^•ã}ÁçÁ]i|çã^Á

### MARKING



ÖÖ65SN10L MÜããç [ÉÁ  
 Ú[ãÁç]cMÚçFÁæáÁçãç]ÉÁ  
 ÝÝMÔ[á^ÉÁ

### EQUIVALENT CIRCUIT



### ABSOLUTE MAXIMUM RATINGS ( $T_a=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	$V_{DS}$	100	V
Gate-Source Voltage	$V_{GS}$	$\pm 20$	V
Continuous Drain Current	$I_D^{(1)}$	65	A
Pulsed Drain Current	$I_{DM}^{(2)}$	260	A
Single Pulsed Avalanche Energy	$E_{AS}^{(3)}$	125	mJ
Maximum Power Dissipation	$P_D^{(1)}$	96	W
Thermal Resistance from Junction to Ambient	$R_{\theta JA}^{(6)}$	50	$^\circ\text{C/W}$
Thermal Resistance from Junction to Case	$R_{\theta JC}^{(1)}$	1.3	$^\circ\text{C/W}$
Operating Junction and Storage Temperature Range	$T_J, T_{stg}$	-55~+150	$^\circ\text{C}$

# MOSFET ELECTRICAL CHARACTERISTICS

$T_a=25^\circ\text{C}$  unless otherwise specified

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
<b>Off characteristics</b>						
Drain-source breakdown voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = 250\mu A$	100			V
Zero gate voltage drain current	$I_{DSS}$	$V_{DS} = 80V, V_{GS} = 0V$	$T_J = 25^\circ\text{C}$		1.0	$\mu A$
			$T_J = 125^\circ\text{C}$		100	
Gate-body leakage current	$I_{GSS}$	$V_{DS} = 0V, V_{GS} = \pm 20V$			$\pm 100$	nA
<b>On characteristics</b> <sup>④</sup>						
Gate-threshold voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\mu A$	1.0	2.1	2.5	V
Static drain-source on-state resistance	$R_{DS(on)}$	$V_{GS} = 10V, I_D = 20A$		11	13.5	$m\Omega$
		$V_{GS} = 4.5V, I_D = 10A$		15.5	21	$m\Omega$
<b>Dynamic characteristics</b> <sup>④ ⑤</sup>						
Input capacitance	$C_{iss}$	$V_{DS} = 50V, V_{GS} = 0V, f = 500kHz$		1285		$pF$
Output capacitance	$C_{oss}$			275		
Reverse transfer capacitance	$C_{rss}$			5.5		
Gate resistance	$R_g$	$f = 1MHz$		3.6		$\Omega$
<b>Switching characteristics</b> <sup>④ ⑤</sup>						
Total gate charge	$Q_g$	$V_{GS} = 10V, V_{DS} = 30V, I_D = 25A$		23.0		nC
Gate-source charge	$Q_{gs}$			3.0		
Gate-drain charge	$Q_{gd}$			5.1		
Turn-on delay time	$t_{d(on)}$	$V_{DS} = 30V, I_D = 10A, V_{GS} = 10V, R_G = 10\Omega$		34		ns
Turn-on rise time	$t_r$			33		
Turn-off delay time	$t_{d(off)}$			156		
Turn-off fall time	$t_f$			86		
<b>Drain-Source Diode Characteristics</b>						
Drain-source diode forward voltage	$V_{SD}$ <sup>④</sup>	$V_{GS} = 0V, I_S = 20A$			1.2	V
Continuous drain-source diode forward current	$I_S$ <sup>①</sup>				65	A
Pulsed drain-source diode forward current	$I_{SM}$ <sup>②</sup>				260	A

Ⓜ [ 0.1A

1.  $T_C = 25^\circ\text{C}$  Limited only by maximum temperature allowed.

2.  $P_W \leq 10\mu s$ , Duty cycle  $\leq 1\%$ .

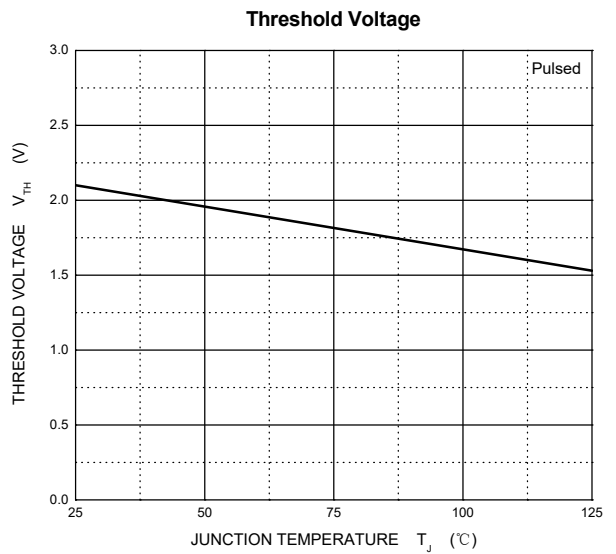
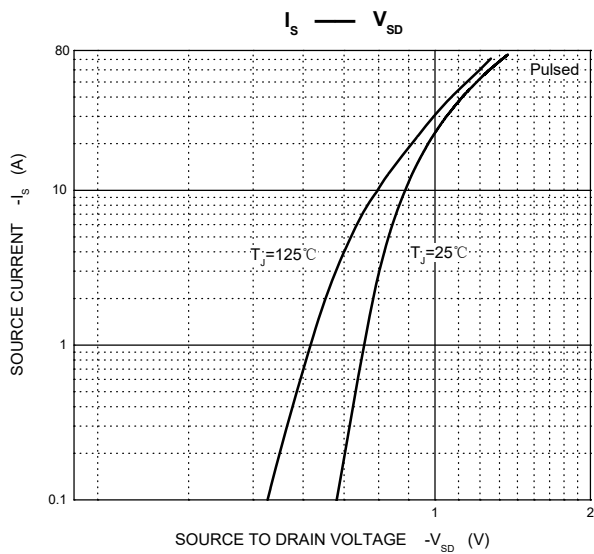
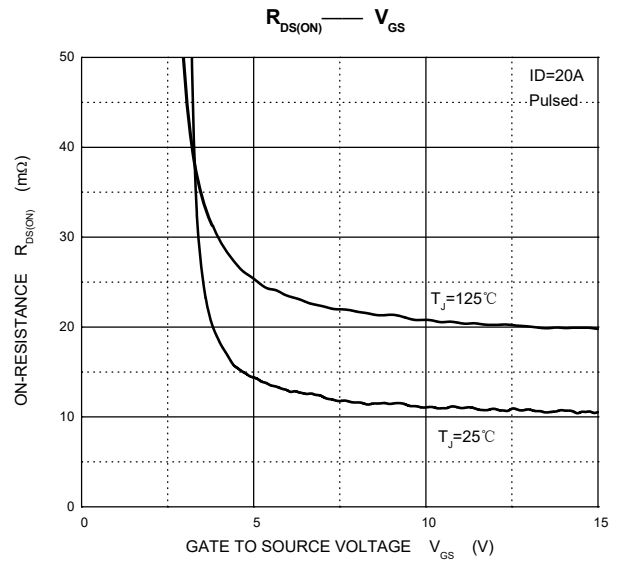
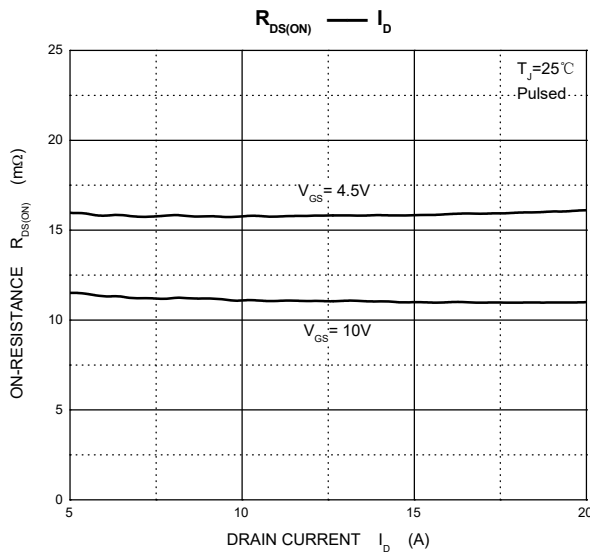
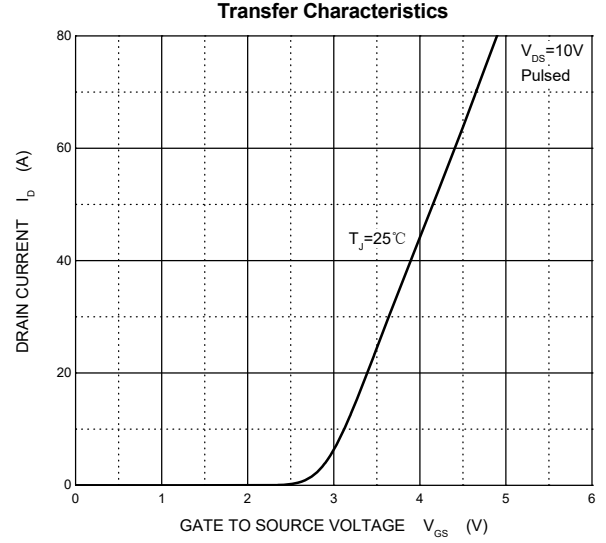
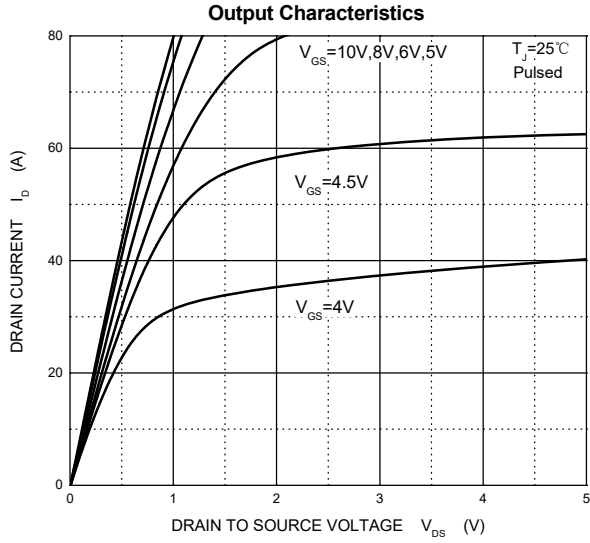
3. EAS condition:  $V_{DD} = 50V, V_{GS} = 10V, L = 0.5mH, R_g = 25\Omega$  Starting  $T_J = 25^\circ\text{C}$ .

4. Pulse Test : Pulse Width  $\leq 300\mu s$ , duty cycle  $\leq 2\%$ .

5. Guaranteed by design, not subject to production.

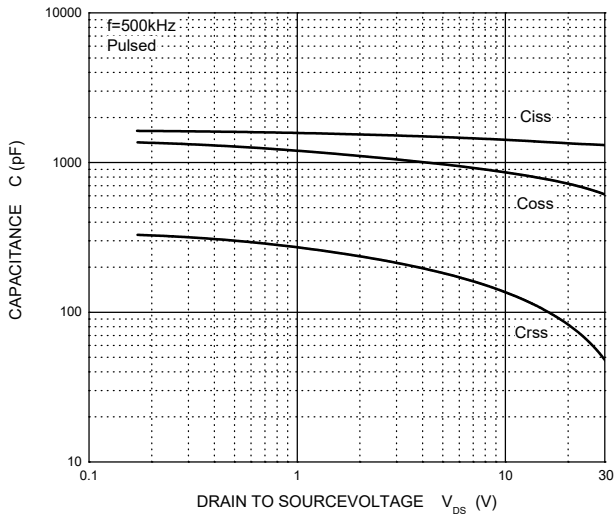
6. The value of  $R_{\theta JA}$  is measured with the device mounted on 1 in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with  $T_a = 25^\circ\text{C}$ .

# Typical Characteristics

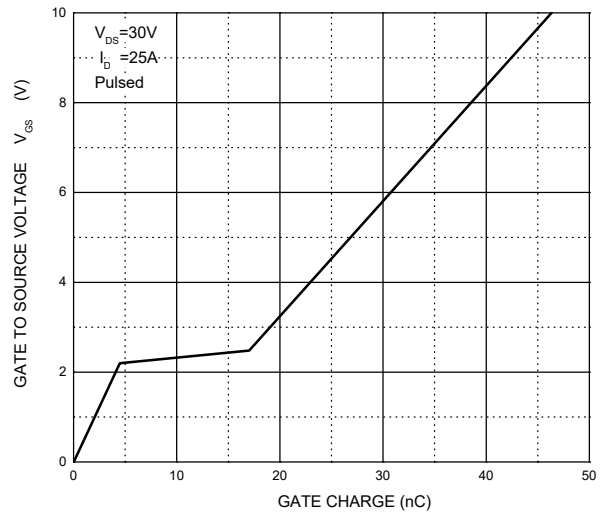


# Typical Characteristics

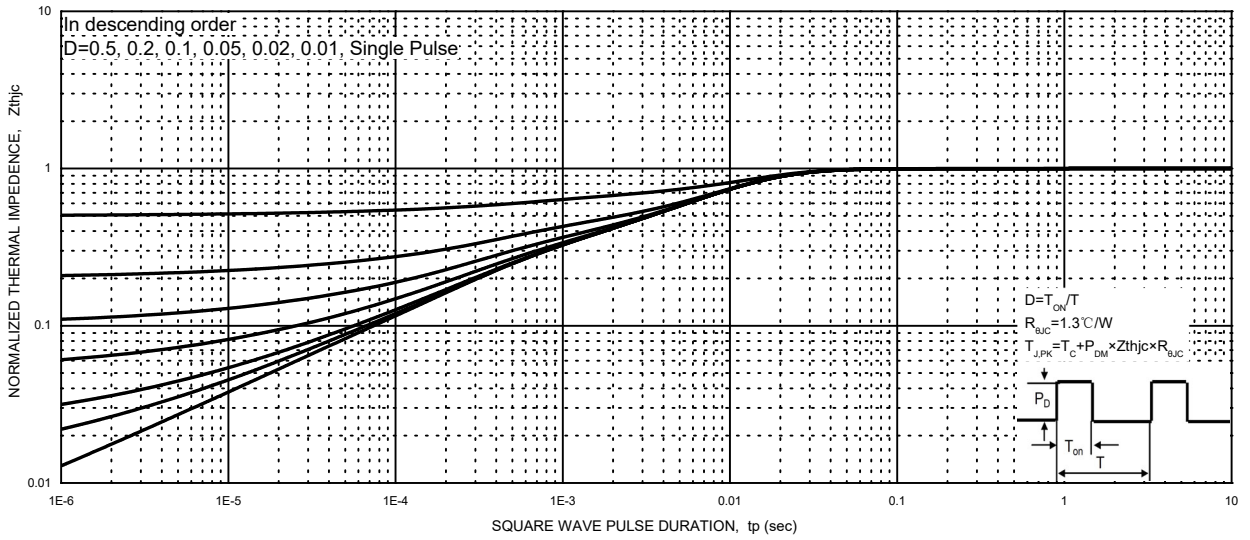
Capacitances



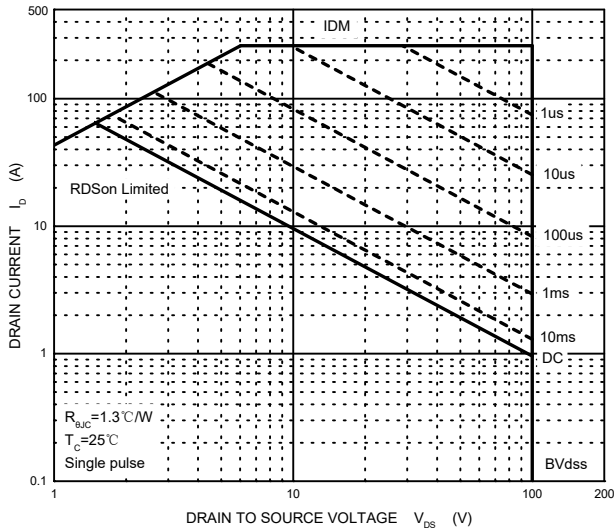
Gate Charge



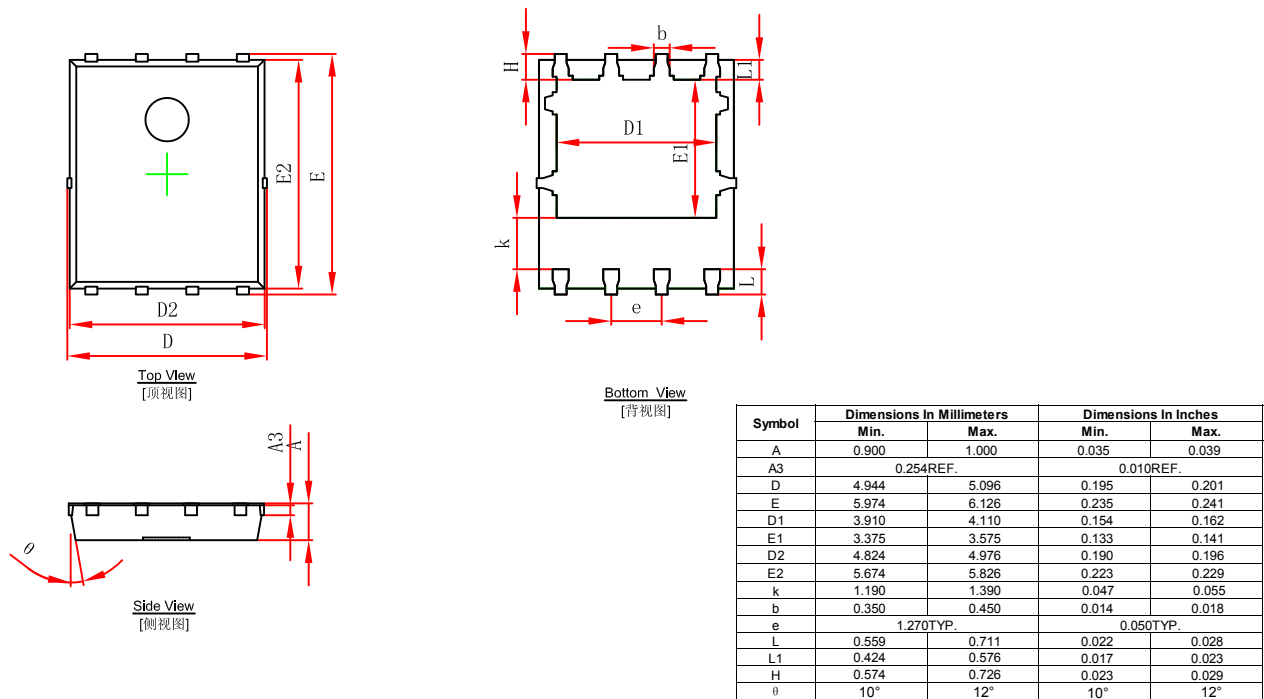
NORMALIZED TRANSIENT THERMAL IMPEDANCE



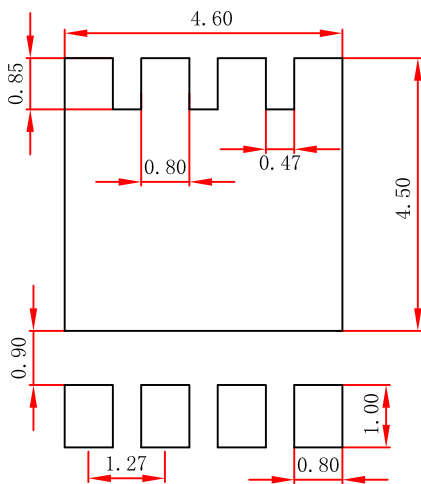
MAXIMUM FORWARD BIASED SAFE OPERATING AREA



## PDFNWB5x6-8L Package Outline Dimensions



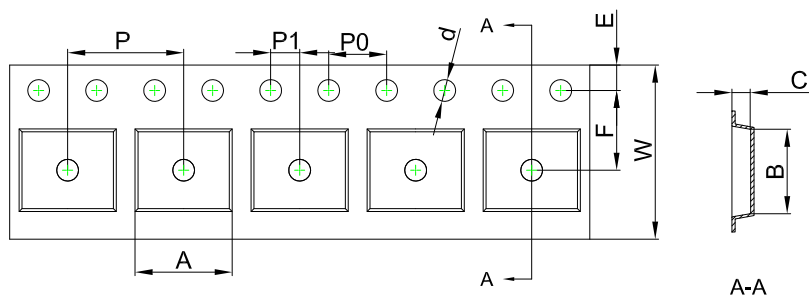
## PDFNWB5x6-8L Suggested Pad Layout



- Note:
1. Controlling dimension: in millimeters.
  2. General tolerance:  $\pm 0.05$  mm.
  3. The pad layout is for reference purposes only.

# PDFNWB5×6 Tape and Reel

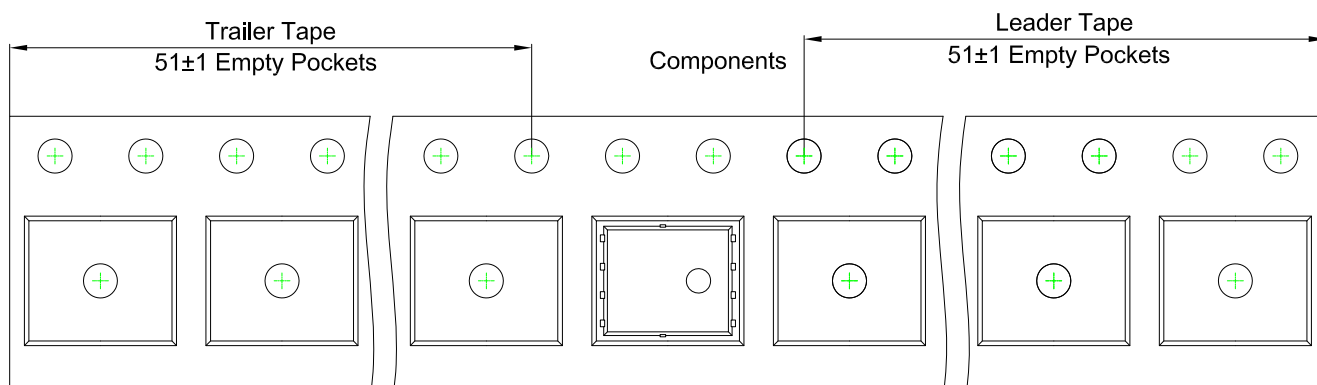
## PDFNWB5×6-8L Embossed Carrier Tape



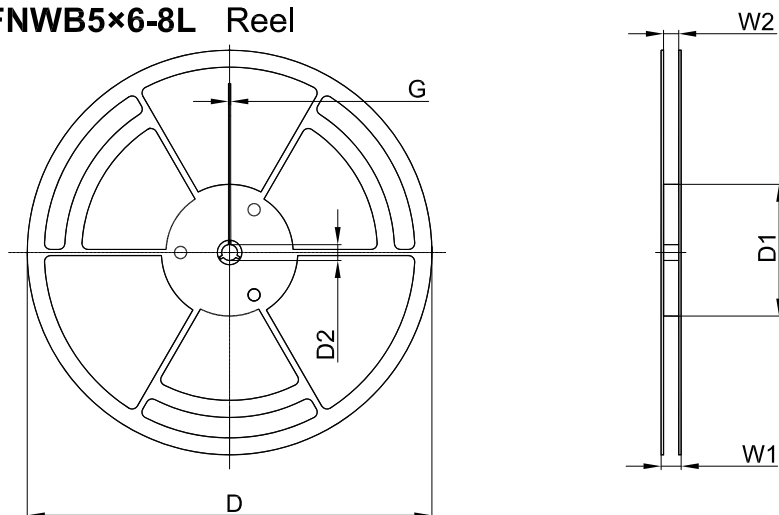
**Packaging Description:**  
**PDFNWB5×6-8L** parts are shipped in tape. The carrier tape is made from a dissipative (carbon filled) polycarbonate resin. The cover tape is a multilayer film (Heat Activated Adhesive in nature) primarily composed of polyester film, adhesive layer, sealant, and anti-static sprayed agent. These reeled parts in standard option are shipped with 5,000 units per 13" or 33.0 cm diameter reel. The reels are clear in color and is made of polystyrene plastic (anti-static coated).

Dimensions are in millimeter										
Pkg type	A	B	C	d	E	F	P0	P	P1	W
PDFNWB5×6-8L	6.30	5.30	1.10	Ø1.50	1.75	5.50	4.00	8.00	2.00	12.00

## PDFNWB5×6-8L Tape Leader and Trailer



## PDFNWB5×6-8L Reel



Dimensions are in millimeter						
Reel Option	D	D1	D2	G	W1	W2
13"Dia	Ø330.00	100.00	13.00	1.90	17.60	12.40

REEL	Reel Size	Box	Box Size(mm)	Carton	Carton Size(mm)
5,000 pcs	13 inch	5,000 pcs	340×336×29	50,000 pcs	353×346×365